

「小型加速器による小型高輝度X線源と イメージング基盤技術開発」

(スポーク型超伝導空洞開発に於ける
設計及び非破壊検査)

Y. Iwashita
Kyoto U.



2013.06.26

H25年度の計画と目的

(1)原子力機構で行うスポーク空洞本体、および、高次モード(HOM)カップラーの設計最適化の過程において、計算機シミュレーションによるマルチパクタリング解析を行う。マルチパクタリングが運転の障害となる可能性のある事が判明した場合、設計へ反映させる。

(2)複雑な構造を持ったスポーク空洞における非破壊検査の手法について設計検討を行う。

(3) SRF2013に参加し、超伝導空洞高分解能内視鏡やTmap,Xmap等、非破壊検査に関する発表を行い、同時に、超伝導加速器の世界動向について調査を行う。



Multipactoring

Proceedings of LINAC2012, Tel-Aviv, Israel

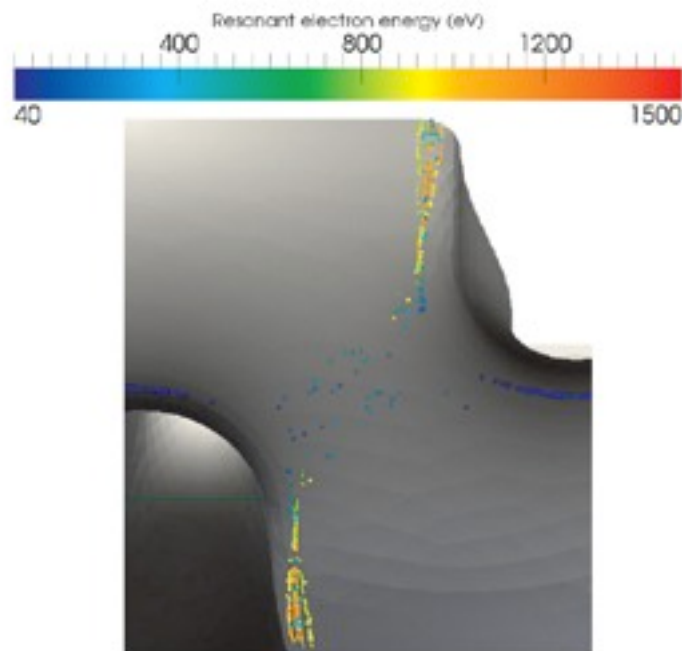
MOPB056

MULTIPACTING ANALYSIS OF HIGH-VELOCITY SUPERCONDUCTING SPOKE RESONATORS*

C. S. Hopper[†] and J. R. Delayen

Center for Accelerator Science, Department of Physics,
Old Dominion University, Norfolk, VA, 23529, USA and

Thomas Jefferson National Accelerator Facility, Newport News, VA 23606, USA



g spoke cavi-
high-velocity
ed geometry,
ts multipact-
he results of
ions of mul-
cavities and

requencies of
of $\beta_0 = 0.82$

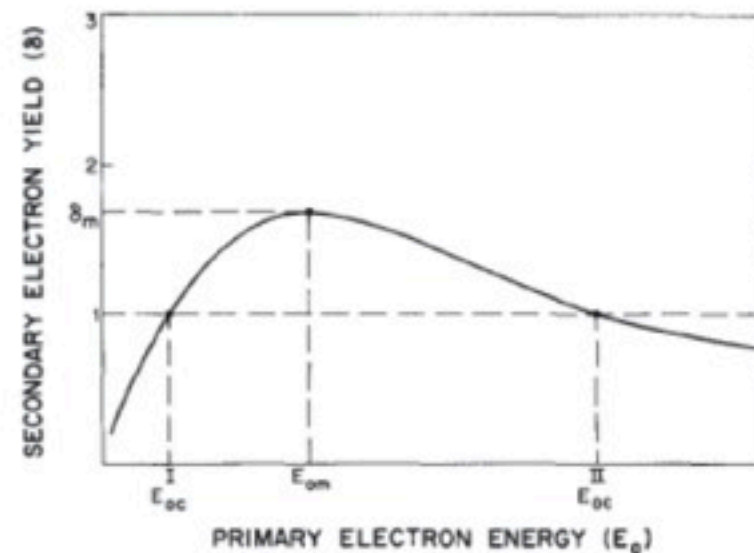


Figure 6: Resonant electrons and their impact energies surviving after 50 rf cycles as simulated by Track3P.

非破壊検査



2013.06.26

13年7月21日日曜日

CavCam2

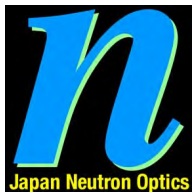
Camera to observe the appearance
of wall surface in the cavity



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e-mail: hoshiya@repic.co.jp



Japan Neutron Optics Inc.

Riken-Wako Incubation Plaza 407

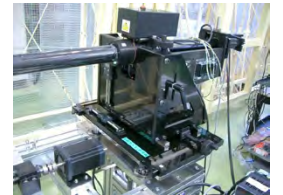
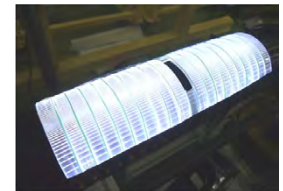
Minami 2-3-13, wako, Saitama, 351-0104, Japan

e-mail: info@j-nop.com

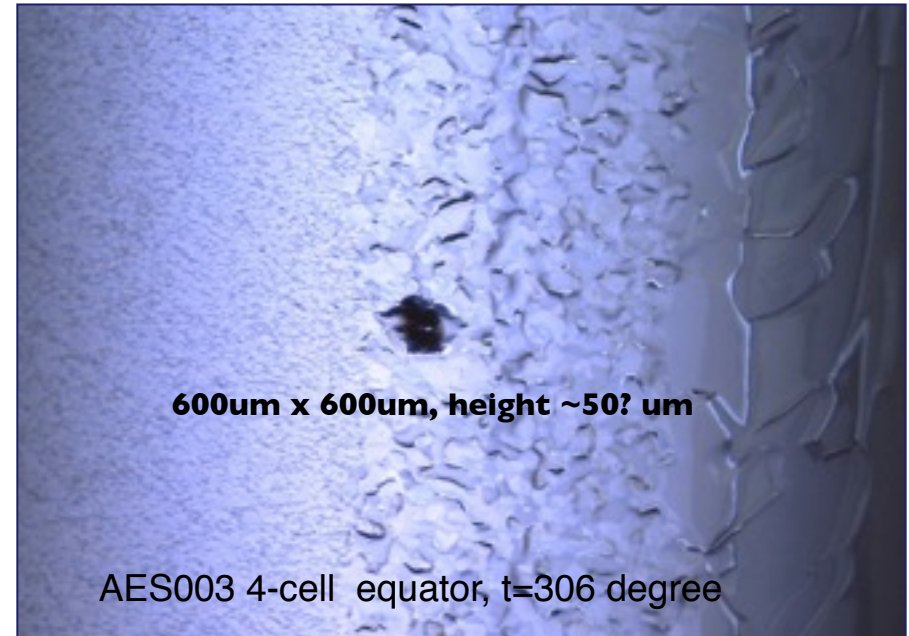
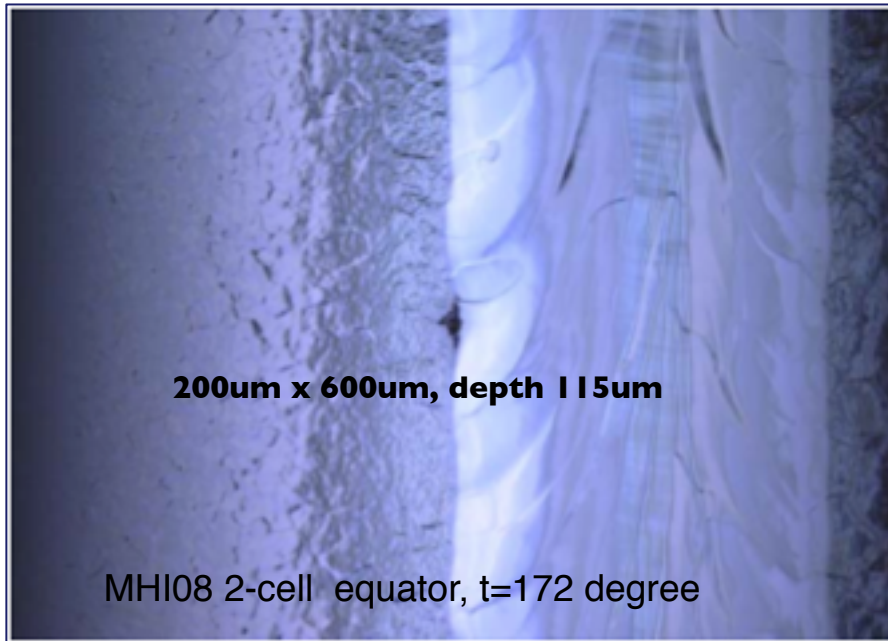
URL <http://www.j-nop.com>

Details of CavCam2 Module Package

- 1) CavCam2-Cylinder "Upper Module of CavCam2"
Weight < 20 kg
 - (1) Camera
9M Pixel color CMOS Camera
Better than 4 microns/pixel (about 3.7 micron/pixel)
Focus adjustable by movement of camera position
USB interface to PC with English viewer software, driver software and manual
 - (2) Mirror
Adjustable tilt angle of the mirror by pulse motor
 - (3) Illumination
Ten white-LEDs at both sides of camera window
Semi-coaxial illumination by LED through the mirror
The illumination housing slides with the mirror tilting angle synchronously.
 - (4) Illumination control box
Illumination on/off for 21 LEDs
Illumination intensity for LED are adjustable
 - (5) Camera cylinder holder
Cylinder positions are adjustable in horizontal and vertical direction with position indicators.
The cylinder tilt angle and yaw angle are also adjustable.
 - The cylinder itself is rotatable by pulse motor from 0 to 360 degree and its angle is displayed to LED indicator and also readable from RS232C.
 - The cylinder rotation axis is adjustable by two fine pitch screws to make camera axis in the rotation center.A built-in damper against the cylinder vibration
 - (6) Cylinder alignment to cavity
Camera cylinder has rotatable red laser indicator which will guide you the cylinder direction to avoid touch to cavity iris.
 - (7) motor controller
2 ch pulse motor controller for focus adjustment and mirror angle adjustment.
Another 2 ch pulse motor controller (only 1-ch is used) for cylinder rotation.
These two controllers are linked together so that one handy control terminal can control all three channel.
- 2) CavCam2-Table "Lower module of CavCAM2"
 - (1) Table body
Width: 581 mm
Height: 1023 mm
Length: 2950 mm (table at operation), 2950 + 339 mm (including cylinder tail)
2090 mm (retractable for transportation)
Stroke: 1500 mm
Weight: < 230 kg
Cavity rotates by pulse motor.
 - (2) Rotary encoder for cavity rotation angle measurement
 - (3) Motor controller
2-ch pulse motor controller, handy terminal
 - (4) The camera cylinder holder sits on the table.



Local Grinding Treatment of Quenched Part



**Pit; appeared after bulk EP,
limit to 16MV/m**

**Bump at heat affecting zone,
limit to 20MV/m**



local grinding & EP

27MV/m



additional EP

38MV/m



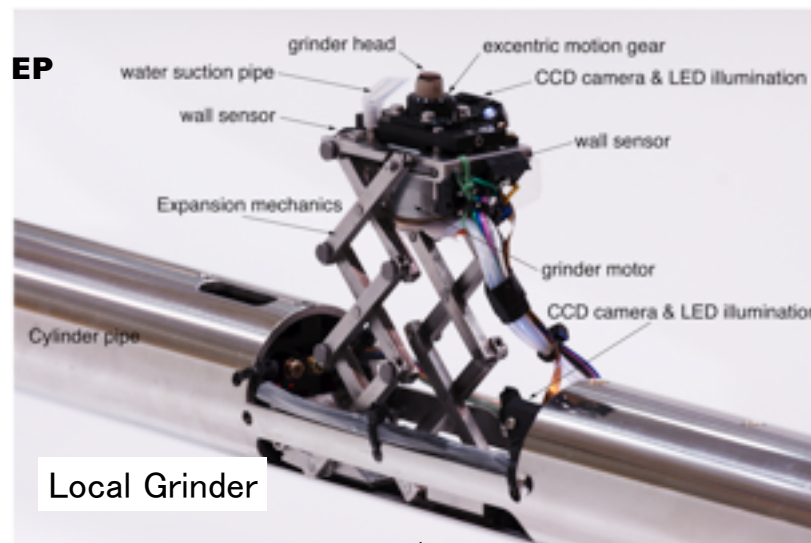
local grinding & EP

30MV/m



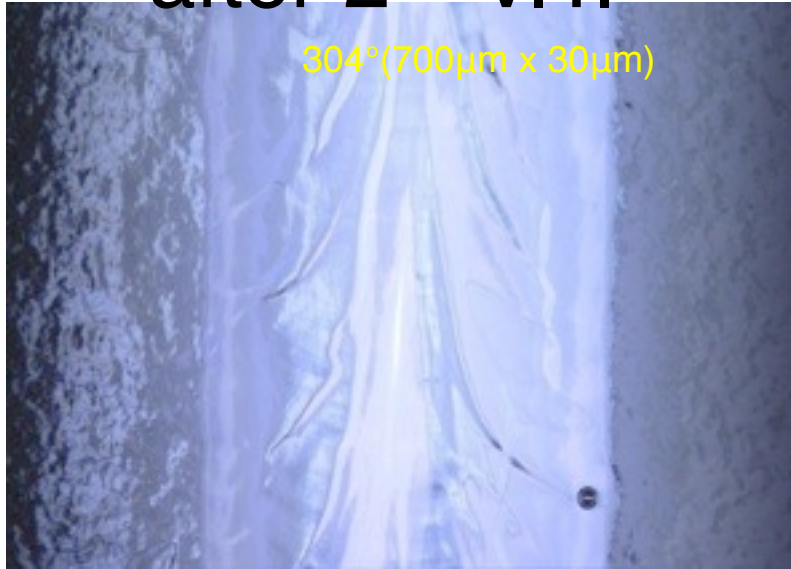
additional HPR and bake

34MV/m



Example of Local Grinding after 2nd V.T.

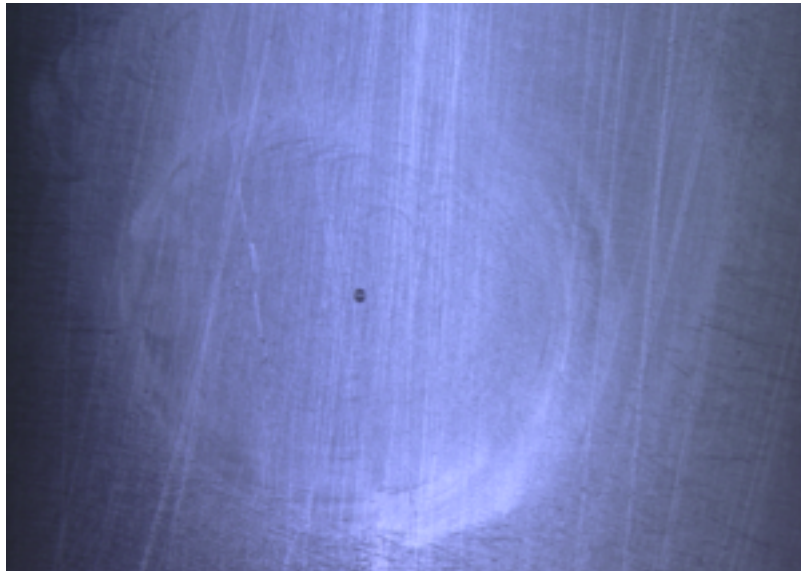
grinding by



Local Grinding

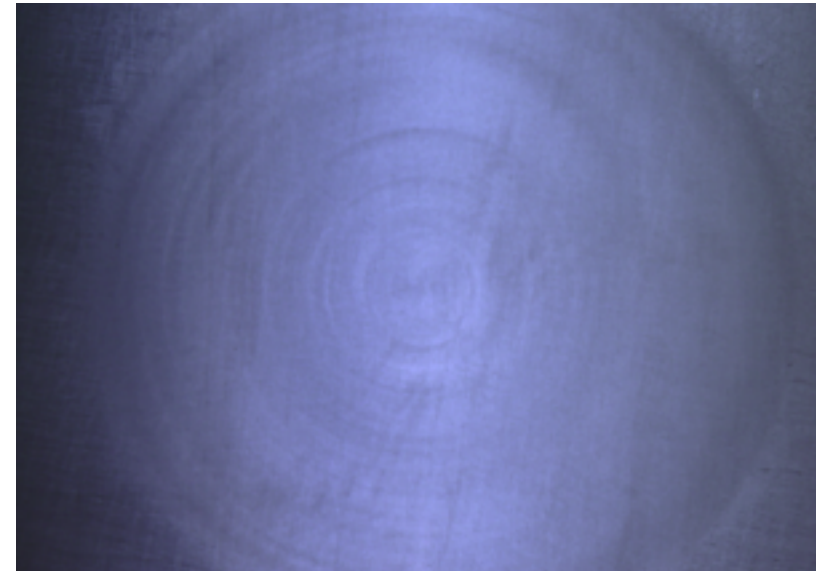


machine



Local Grinding

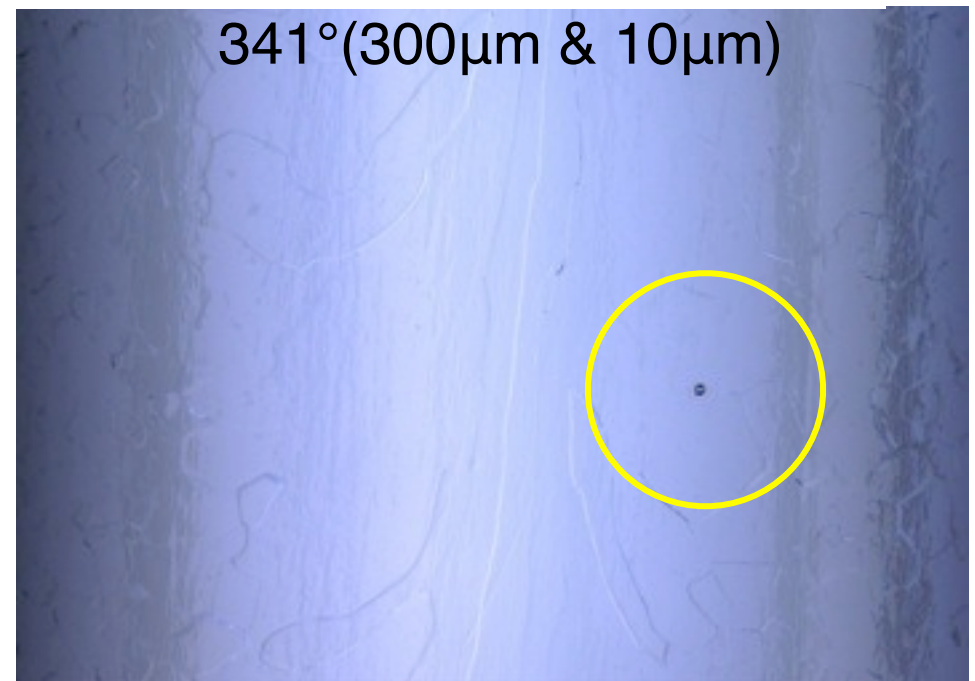
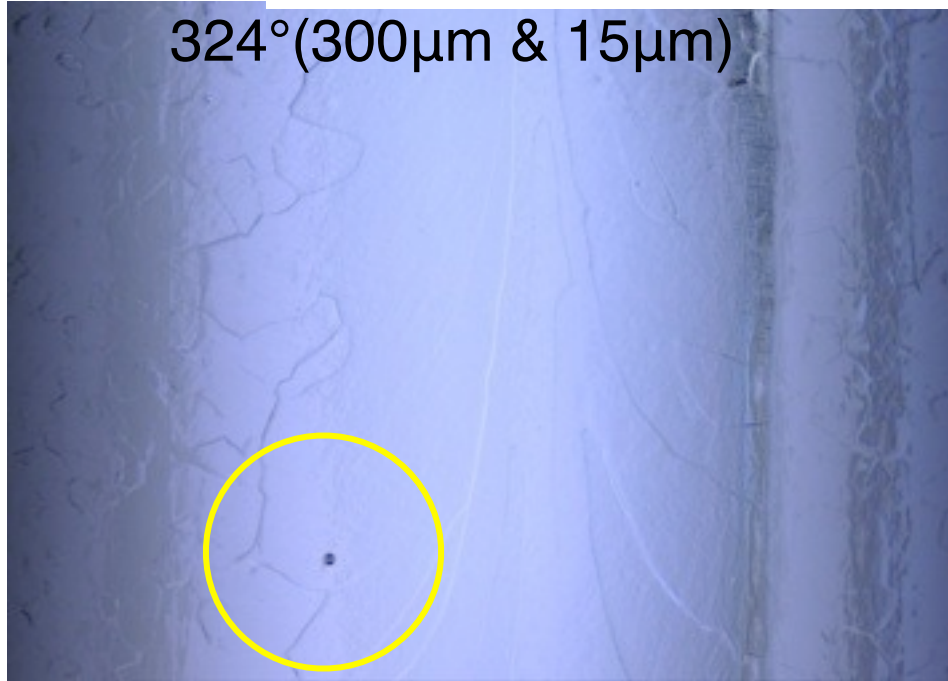
finish



Local Grinding

Yasuchika Yamamoto

After the LocalGrinding and EP, new defect appeared!
Furthermore, it grew with the LocalGrinding!



MHI-010:

1st VT 23.8MV/m @ Q0=1.1E10 May 20,2010

2nd VT 25.7MV/m @Q0=8.1E9 June 17,2010



local grinding and 100mm EP

3rd VT 20MV/m @ Q0=1.1E10 Sep 02,2010



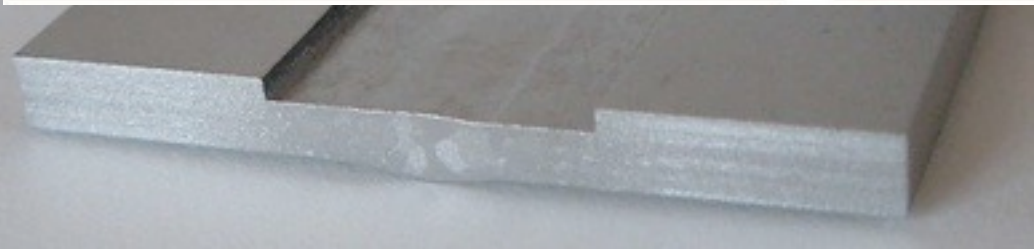
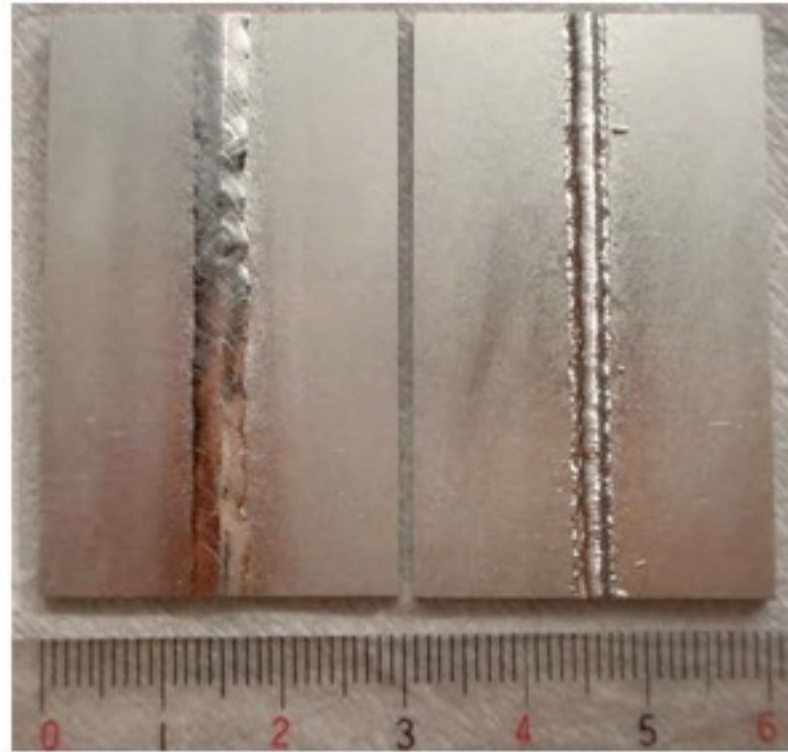
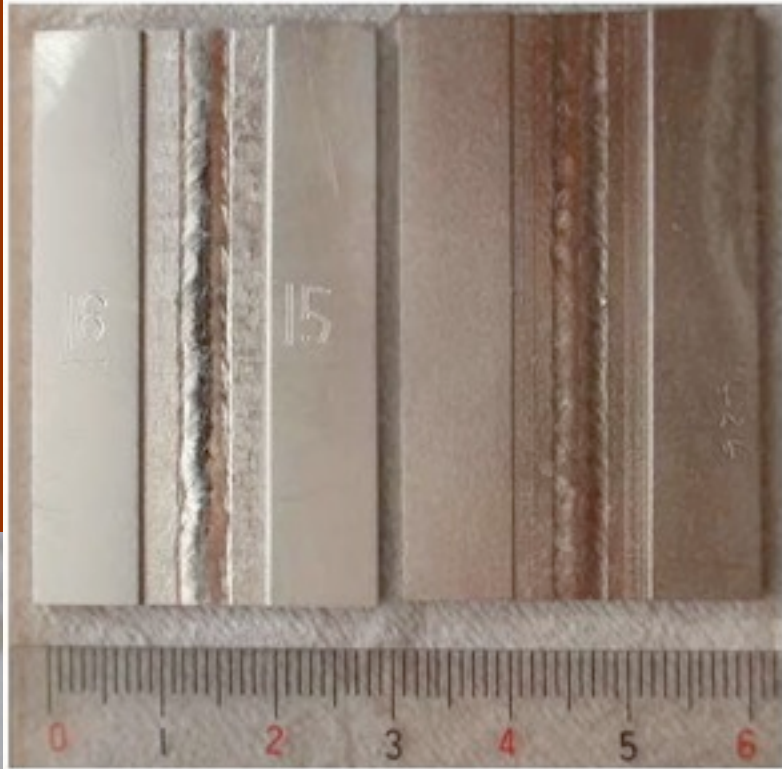
X-Ray Imaging



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Nb EBW Samples

Prepared at KEK



Imaging of Nb sample

Layout

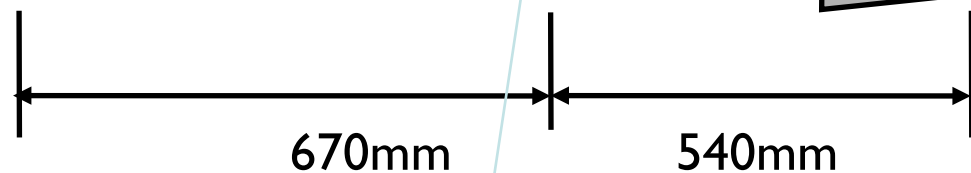
W Micro Focus X-ray Source
Large Focus Mode
120kV, 300 μ A



Led Shield (direct contact to the Sample)

Nb Sample

CCD Camera
18 μ m/pixel
Size: 3000pixel \times 3000pixel
(54.0mm \times 54.0mm)
Exposure Time: 600sec



15mm between Sample and Detector

Slit:
V24mm x H8mm

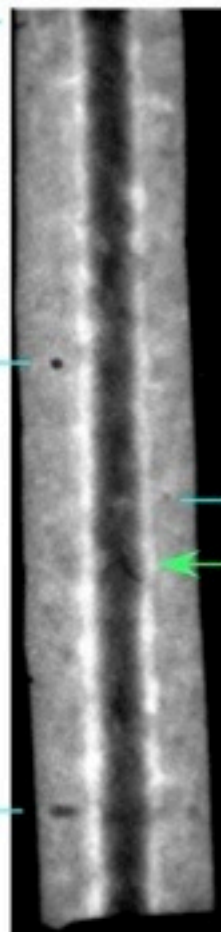
Nb Sample Imaging Area:
V50mm x H7mm
(Actual vertical size was limited by the slit size)

Courtesy of Dr. Yashiro @ Momose Lab., U-Tokyo

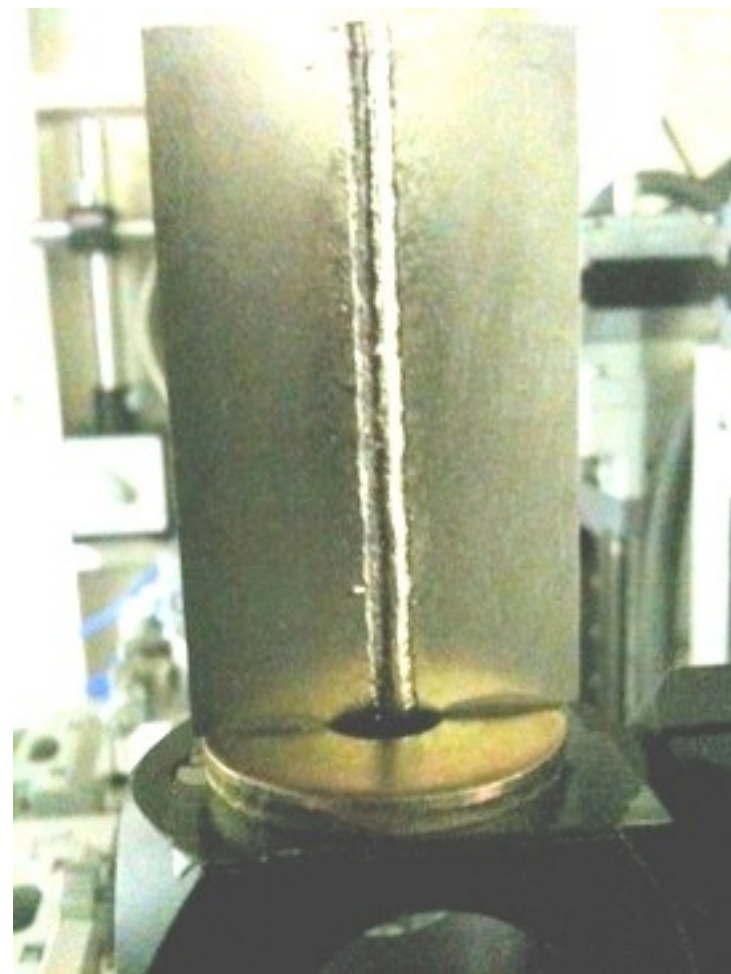


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Transmission (Gray Scale : 0.3~0.55)



X-ray radiography
Nb EBW sample 426
by Dr.Yashiro



2010.8.2 lw



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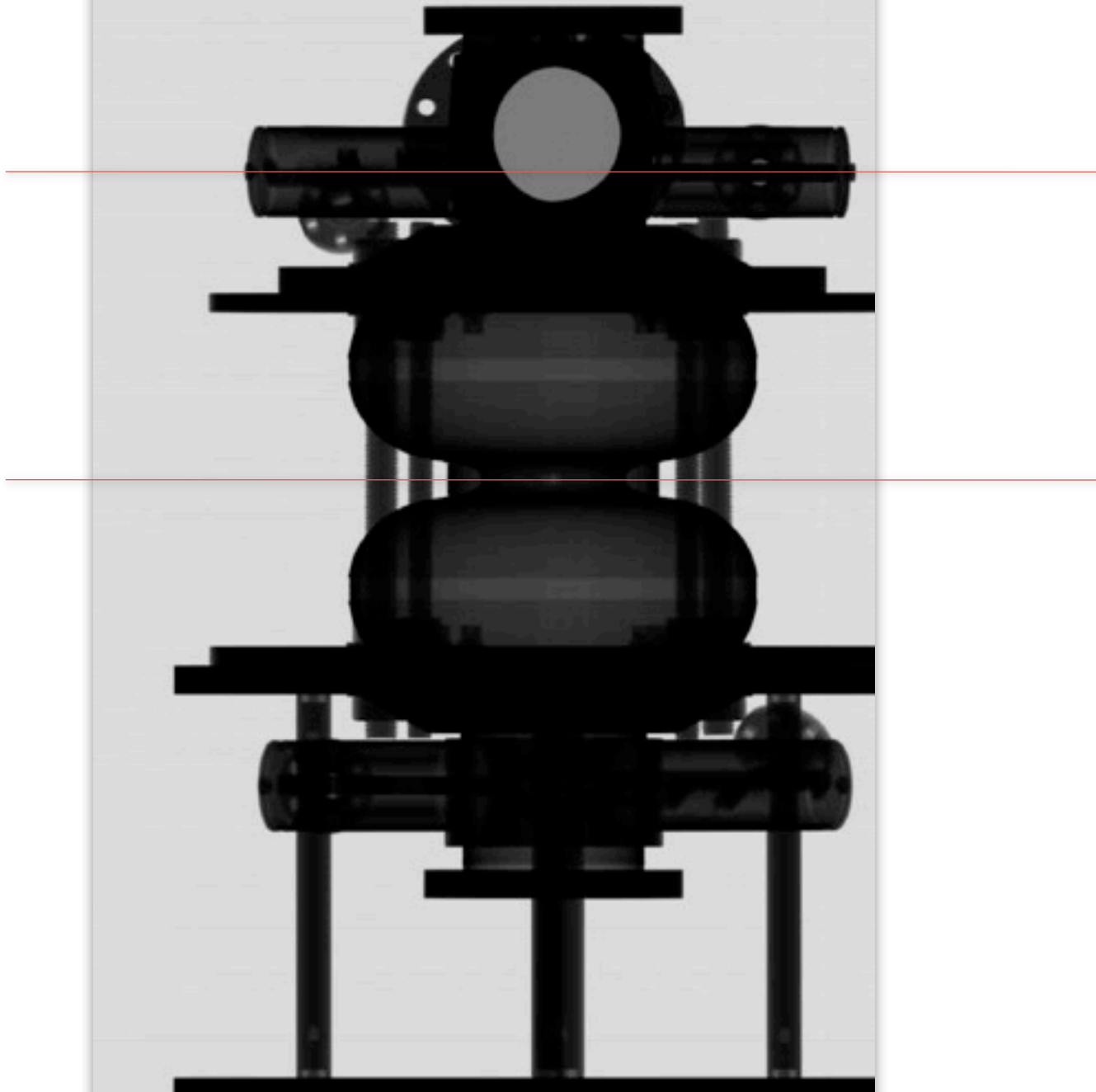


Y.CT Compact

Y
XLON
International



Two Cell Cavity





Neutron Imaging



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Neutron CT



50x50mm



ø1.5 thru hole

ø0.5 x 2.5, ø0.2 WC

Mat'l	Abs. xs	
Nb	1.15	41
Ta	20.6	73
W	18.5	74



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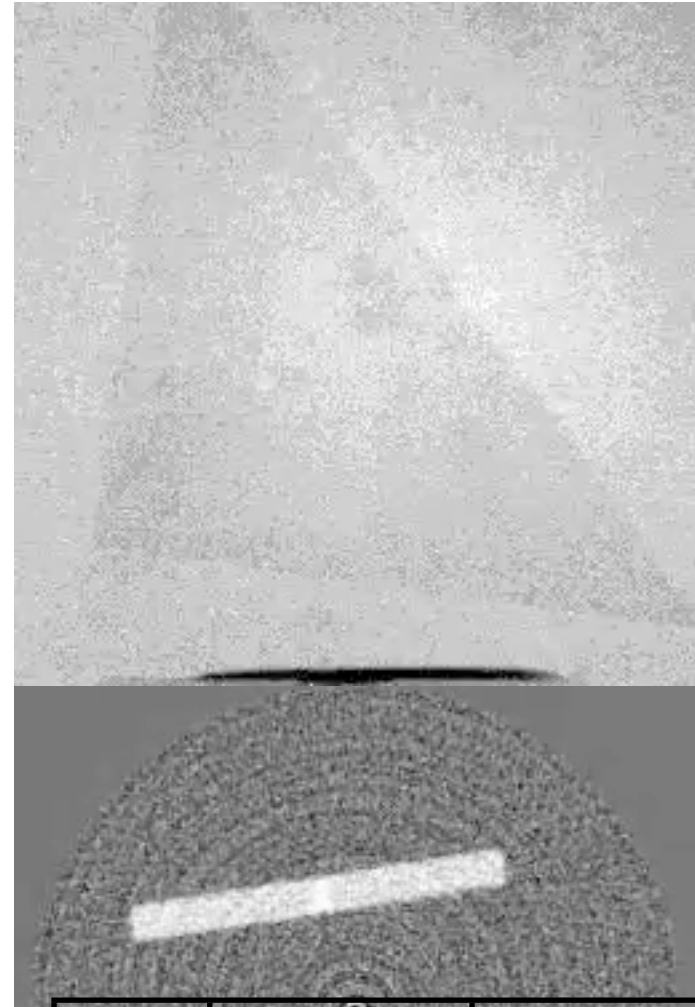
Neutron CT



50x50mm

ø1.5 thru hole

ø0.5 x 2.5, ø0.2 WC

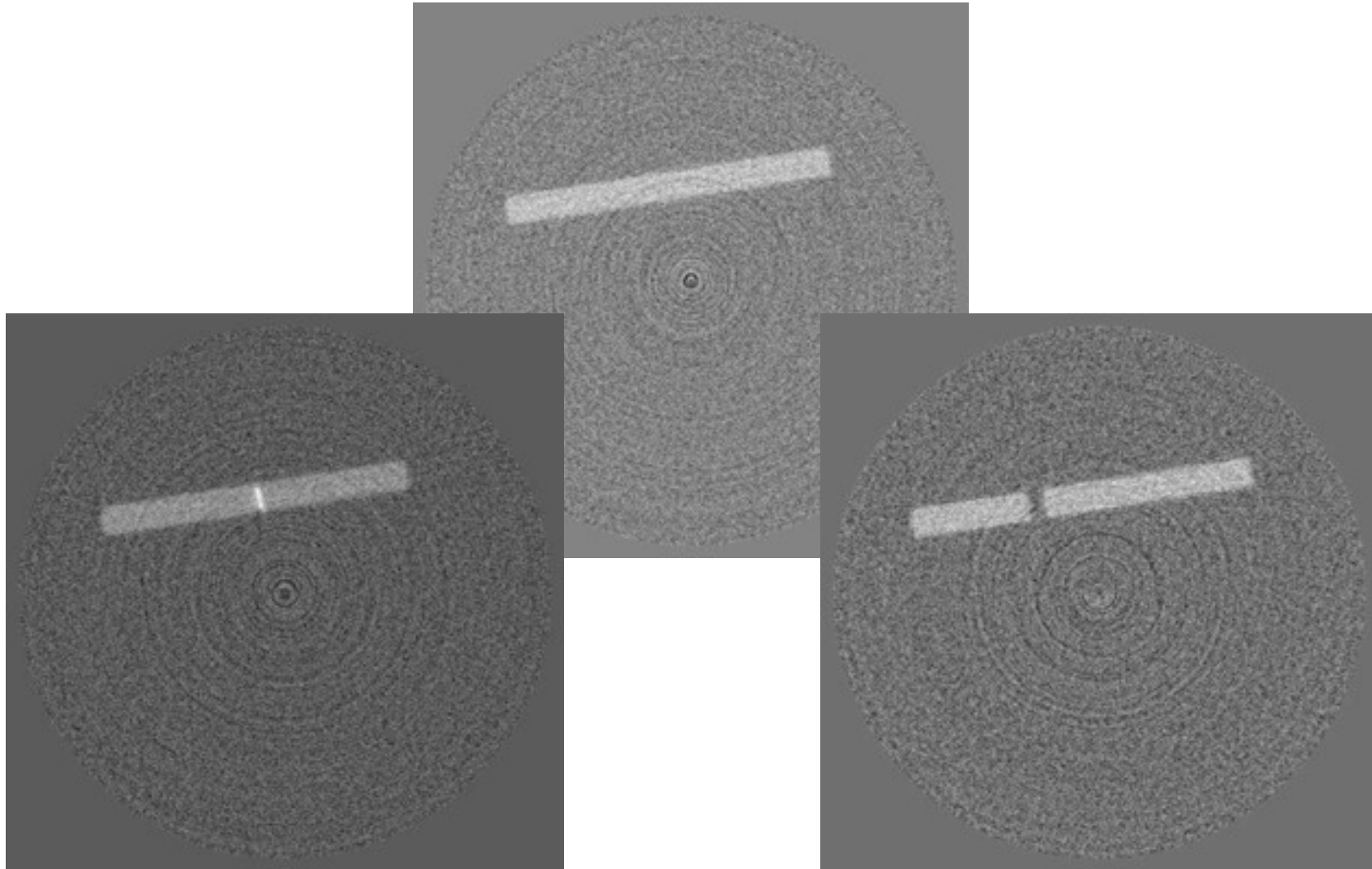


Mat'l	Abs. xs	
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Neutron Imaging



ø0.2 WC

ø1.5 thru hole



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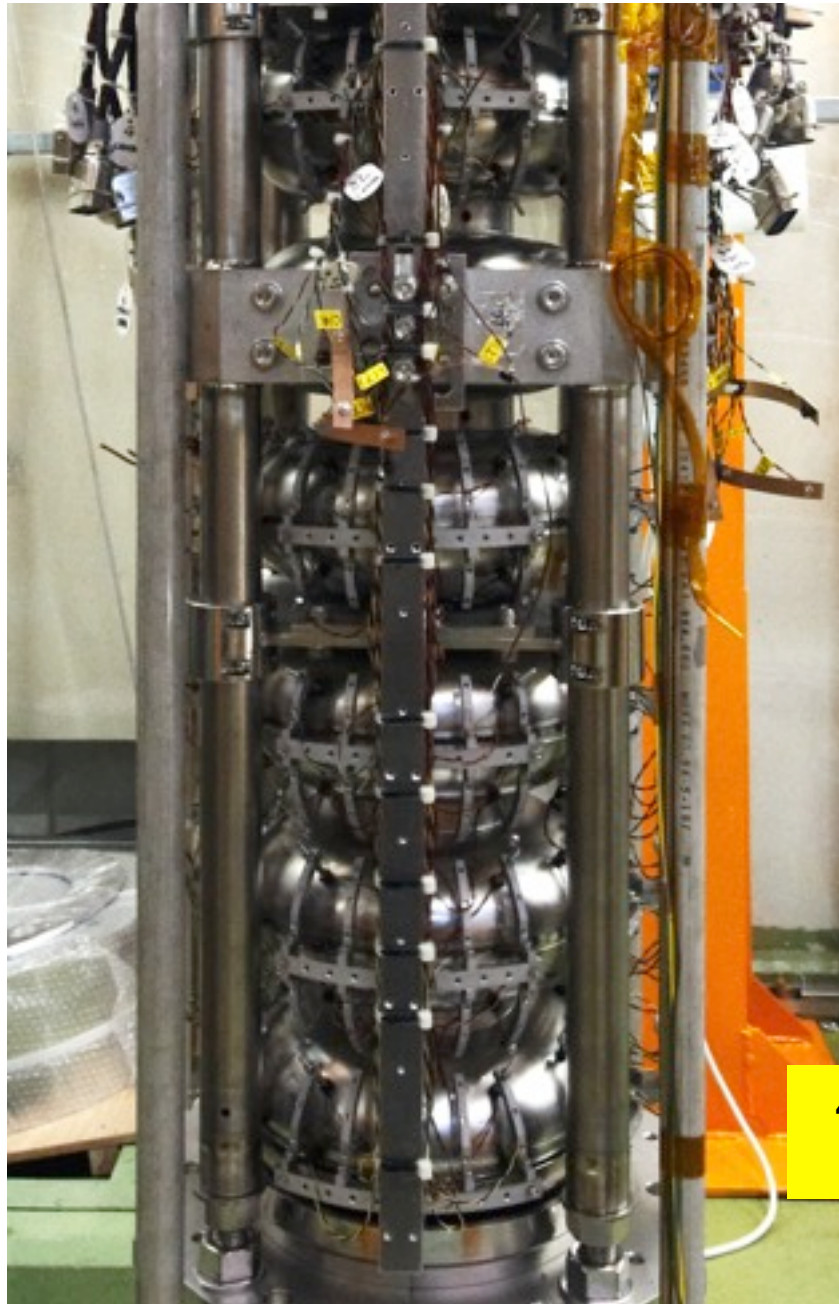
Tmap, Xmap



Tmap and Xmap are used during Vertical Test

T-sensors are installed on the surface:
on equators and walls.

352 carbon resistors
(Allen-Bradley, 50 or 100Ω)



X-sensors on Iris
142 PIN diodes
(HAMAMATSU, S1223-01)

494 sensors total,
55 sensors/cell

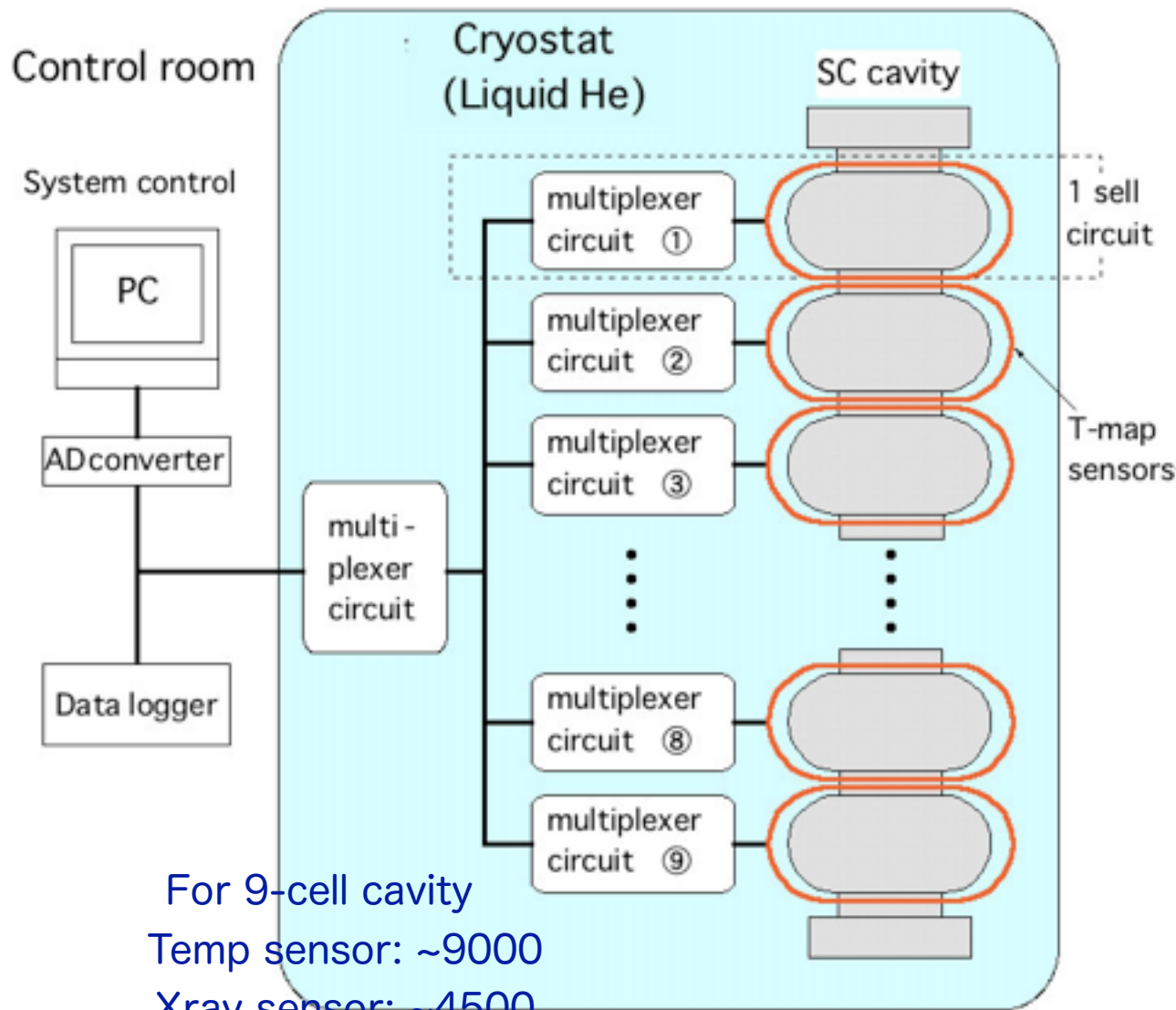


Yasuchika Yamamoto

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High resolution XT-map with Multiplexer

Electron trajectory and emission point can be speculated by XT-map information



For 9-cell cavity

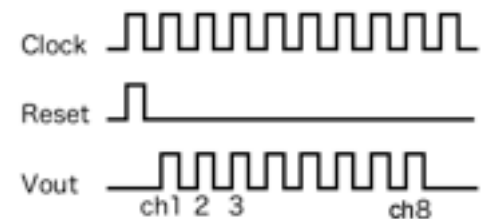
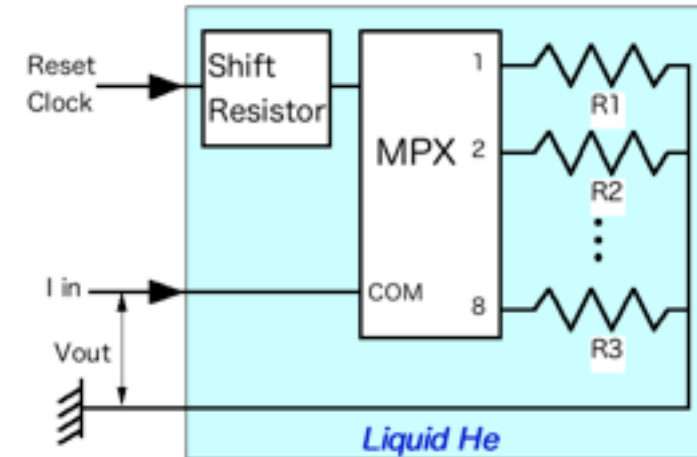
Temp sensor: ~9000

Xray sensor: ~4500

cable feed-through: 25 lines

read out speed: ~1 sec/9cell

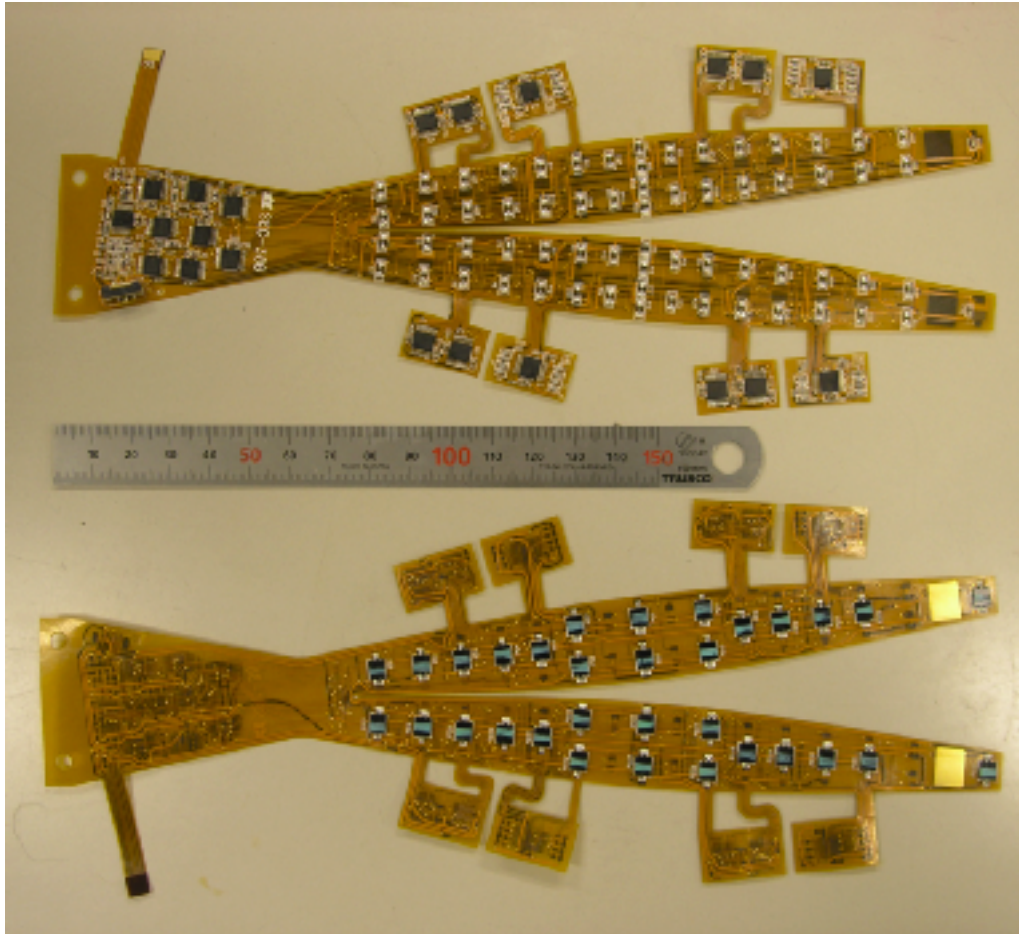
CMOS MPX circuit



Many sensor signals can be handled with the small number of lines by multiplexing technique.

High Density XT-map

64 T-sensors / double leaf



32 X-sensors / double leaf

XT-sensors



XT-map PCB installed
on the cavity surface

T-map signal

クエンチ検出試験 π モード

HIT#1で発熱感知 (KEK T-map)

2012.10.18
File No. 0012 - 23

- 100mA~
- 70mA~
- 40mA~
- 20mA~
- 10mA~
- 3mA~
- 0mA~
- OPEN
- SHORT

